



FEATURES

- 5W class
- High surge capability for Load Dump Surge
- Meets ISO7637-2 surge specification (Varied by test condition)
- Available for automotive use
- AEC-Q101 qualified
- RoHS compliant

OUTLINE DRAWING



ABSOLUTE MAXIMUM RATINGS

ltems	Symbols	Units	Ratings		
Non-Repetitive Peak Reverse One-Cycle Dissipation	P _{RSM}	W	3,000(Rectangular pulse t=1ms Tj=25°C start)		
Non-Repetitive Peak Reverse Surge Current	I _{RSM}	А	62(Time constant=14.5ms, TL=25°C)		
DC Reverse Voltage	V _{DC}	V	18		
Operating Junction Temperature	Tj	°C	-40 ~ +150		
Storage Temperature	T _{stg}	°C	-40 ~ +150		

CHARACTERISTICS(T_L=25°C)

Items	Symbols	Units	Min.	Тур.	Max.	Test Conditions
Zener Voltage	Vz	V	24	27	30	Iz=10mA
Dynamic Impedance	Zz	Ω	-	-	50	Iz=10mA
Zener Voltage Temperature Coefficient	γz	%/°C	-	0.074	-	Iz=10mA
Peak Forward Voltage	V _{FM}	V	-	-	1.2	I _{FM} =6A
Peak Reverse Current	I _{RRM}	μA	-	-	50	V _R =18V



Figure 1. I_{RSM} waveform

HITACHI

ZSH5MA27

Typical zener characteristics



Typical reverse power characteristics (Rectangular pulse non-repetitive)



Precautions for Safe Use and Notices

If semiconductor devices are handled inappropriate manner, failures may result. For this reason, be sure to read "Precaution for Use" before use.



This mark indicates an item about which caution is required.

CAUTION This mark indicates a potentially hazardous situation which, if not avoided, may result in minor or moderate injury and damage to property.

\triangle CAUTION

- (1) Regardless of changes in external conditions during use "absolute maximum ratings" should never be exceed in designing electronic circuits that employ semiconductors. In the case of pulse use, furthermore, "safe operating area(SOA)" precautions should be observed.
- (2) Semiconductor devices may experience failures due to accident or unexpected surge voltages. Accordingly, adopt safe design features, such as redundancy or prevention of erroneous action, to avoid extensive damage in the event of a failure.
- (3) In cases where extremely high reliability is required (such as use in nuclear power control, aerospace and aviation, traffic equipment, life-support-related medical equipment, fuel control equipment and various kinds of safety equipment), safety should be ensured by using semiconductor devices that feature assured safety or by means of user's fail-safe precautions or other arrangement. Or consult Hitachi's sales department staff.
- (4) (If a semiconductor device fails, there may be cases in which the semiconductor device, wiring or wiring pattern will emit smoke or cause a fire or in which the semiconductor device will burst)

NOTICES

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